

SECT Z-Z

25.5	23.6	27.1	51338-1209	120
21.5	19.6	23.1	51338-1009	100
19.5	17.6	21.1	51338-0909	90
17.5	15.6	19.1	51338-0809	80
15.5	13.6	17.1	51338-0709	70
13.5	11.6	15.1	51338-0609	60
11.5	9.6	13.1	51338-0509	50
9.5	7.6	11.1	51338-0409	40
8.3	6.4	9.9	51338-0349	34
7.5	5.6	9.1	51338-0309	30
6.7	4.8	8.3	51338-0269	26
6.3	4.4	7.9	51338-0249	24
5.9	4.0	7.5	51338-0229	22
5.5	3.6	7.1	51338-0209	20
3.9	2.0	5.5	51338-0129	12
C	B	A	MATERIAL No.	CKT.

REVISED EC NO: J2006-0826 DRWN: TAKEMOTO CHKD: TANAKA APPR: NUKITA	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± ---	DRAWN BY M. NINOMI	DATE 2004/03/17	TITLE 0.4 B-T0-B REC ASSY HGT=1.5 J-BEND TAIL -LEAD FREE-				
		10 OVER 30 UNDER	± ---	CHECKED BY K. TOJO	DATE 2004/03/17					
		30 OVER	± ---	APPROVED BY M. SASAO	DATE 2004/03/17	MOLEX INCORPORATED				
		ANGULAR ± --- °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-51338-003		1 OF 2		
		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								



1. 使用材料 MATERIAL
ハウジング：液晶ポリマー（LCP） ガラス充填 UL94V-0（黒）
HOUSING: LIQUID CRYSTAL POLYMER (GLASS FILLED)
UL94V-0 (COLOR: BLACK)
ターミナル：リン青銅（ $t=0.15$ ）
TERMINAL: PHOSPHOR BRONZE ($t=0.15$)
金具：リン青銅（ $t=0.15$ ）
FITTING NAIL: PHOSPHOR BRONZE ($t=0.15$)

2. メッキ仕様 PLATING
ターミナル TERMINAL
金メッキ 0.2マイクロメートル以上（コンタクト部）
GOLD 0.2MICROMETER MINIMUM (CONTACT AREA)
金メッキ 0.4マイクロメートル以下（テール部）
GOLD 0.4MICROMETER MAXIMUM (TAIL AREA)
下地メッキ：ニッケルメッキ 1.5マイクロメートル以上
UNDER PLATING: NICKEL 1.5MICROMETER MINIMUM
*コンタクト部とテール部はニッケルメッキによって分断されている金メッキです。
DIVIDE INTO PARTS THE GOLD PLATING OF THE CONTACT
AND THE TAIL PART BY THE NICKEL PLATING.
金具 FITTING NAIL
錫メッキ 1.0 マイクロメートル以上
TIN PLATING 1.0 MICROMETER MINIMUM
下地メッキ：ニッケルメッキ 1.0 マイクロメートル以上
UNDER PLATING: NICKEL 1.0 MICROMETER MINIMUM

③ (全極数/2) = 偶数の場合に適用。
APPLY FOR (CIRCUIT/2)=EVEN.

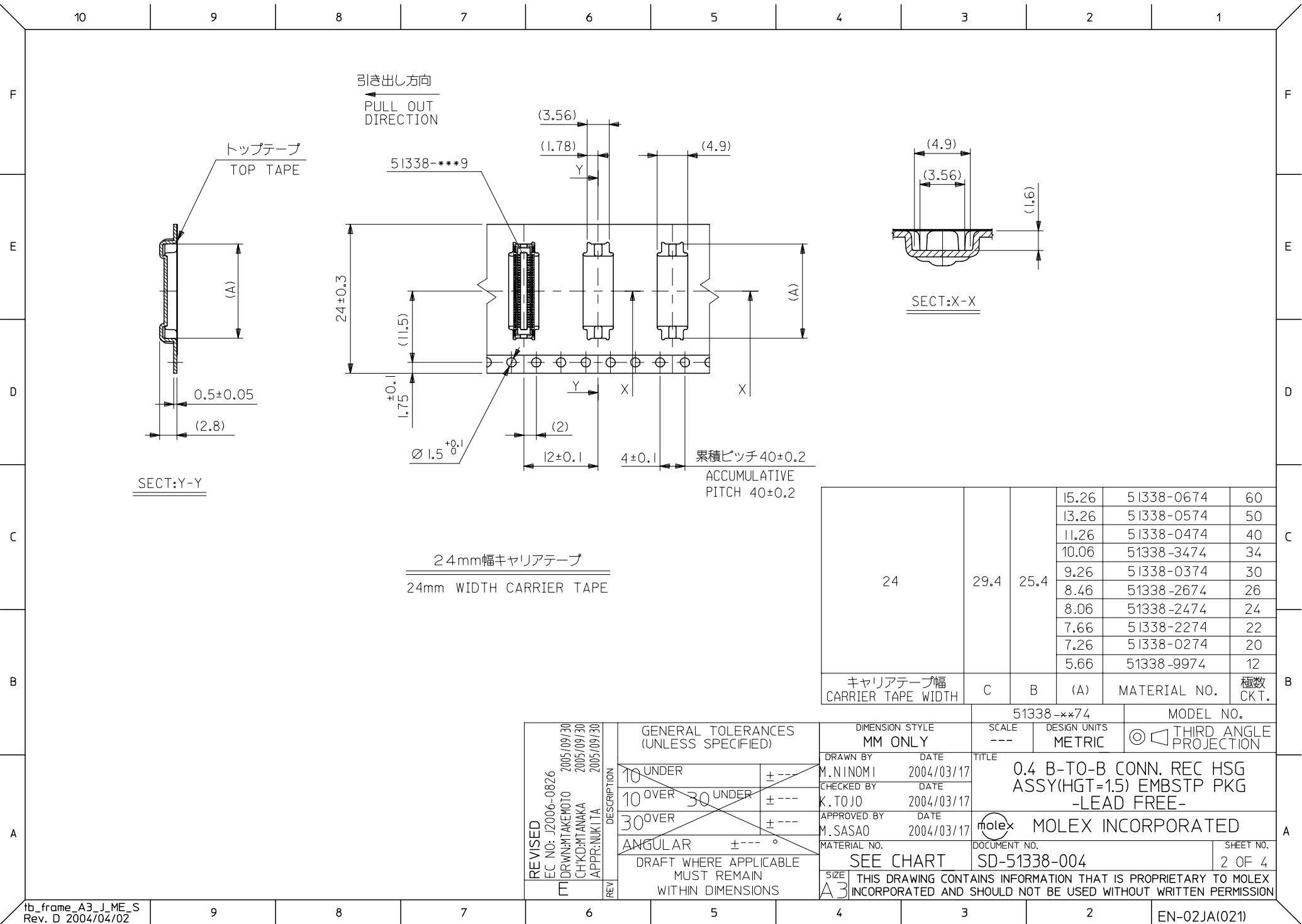
4. 嵌合相手：55909シリーズ
MATE WITH: 55909 SERIES.

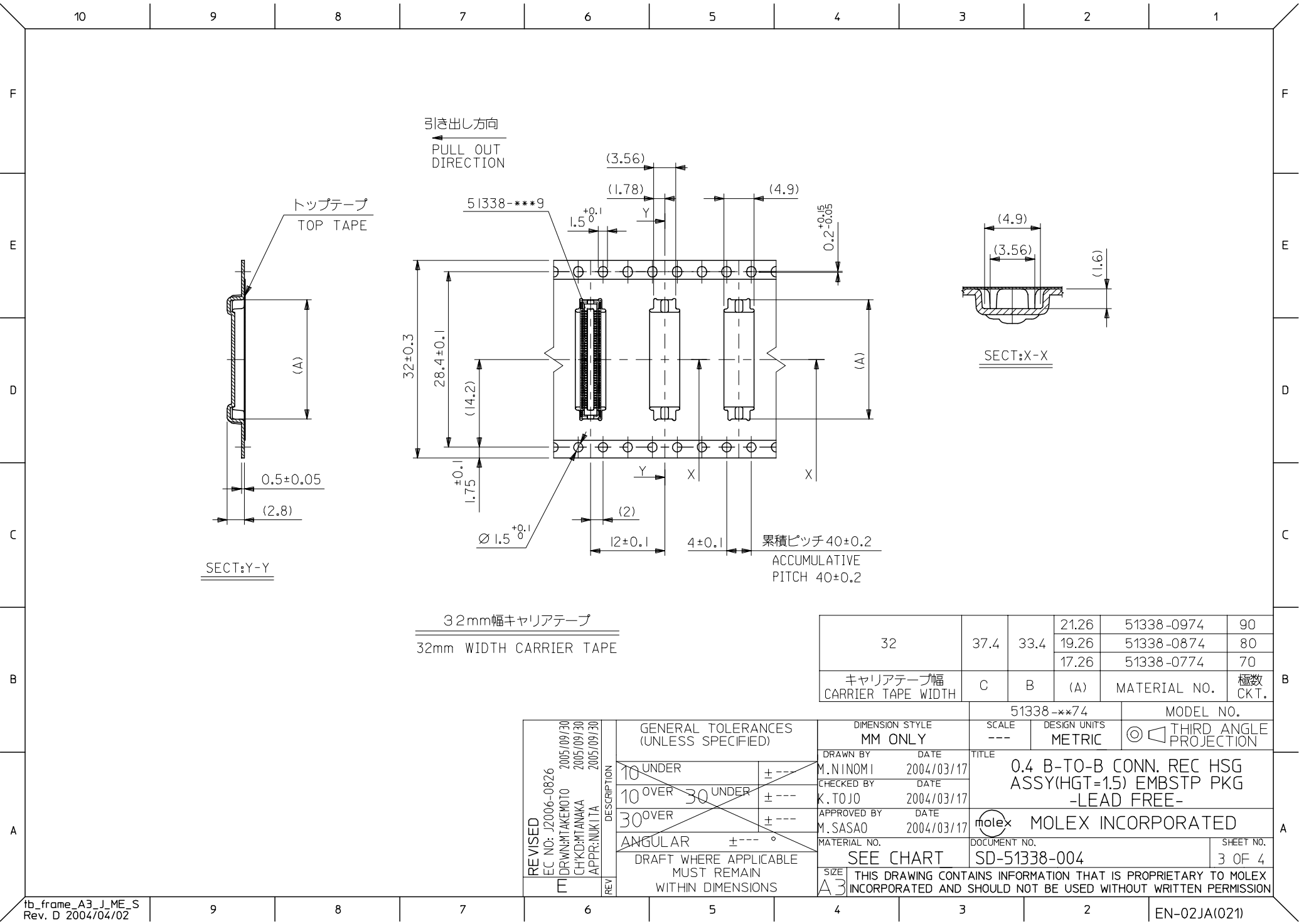
5. テール平坦度は、0.08以下
テール及び金具の平坦度は、0.1以下
TAIL COPLANARITY TO BE 0.08MAXIMUM
TAIL AND FITTING NAIL COPLANARITY TO BE 0.1MAXIMUM

④ 同一回路以外のパターン書込み禁止範囲を示す。
NO PRINT CIRCUIT AREA OTHER THAN THE SAME CIRCUIT.

7. 本製品は 51338-***3 の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 51338-***3.

REVISED	EC NO: J2006-0826	2005/09/30	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		5 1338-***9		MODEL NO.		
	DRWN:MTAKEMOTO	2005/09/30				DRAWN BY DATE		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
	CHKD:MTANAKA			10 UNDER ± ---		M.NINOMI 2004/03/17		TITLE 0.4 B-TO-B REC ASSY HGT=1.5 J-BEND TAIL -LEAD FREE-				
	APPR:NUKITA			10 OVER 30 UNDER ± ---		CHECKED BY DATE K.TOJO 2004/03/17						
				30 OVER ± ---		APPROVED BY DATE M.SASAO 2004/03/17		MOLEX MOLEX INCORPORATED				
				ANGULAR ± --- °		MATERIAL NO.						
				DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SHEET NO. 2 OF 2				
	REV					SIZE A3						





32mm幅キャリアテープ
32mm WIDTH CARRIER TAPE

32	37.4	33.4	21.26	51338-0974	90
			19.26	51338-0874	80
			17.26	51338-0774	70
キャリアテープ幅 CARRIER TAPE WIDTH	C	B	(A)	MATERIAL NO.	極数 CKT.

REVISED EC NO: J2006-0826 DRWN:TAKEWOTO 2005/09/30 CHKD:MTANAKA 2005/09/30 APPR:NUKITA 2005/09/30	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		51338-**74		MODEL NO.	
		10 UNDER ±---		DRAWN BY DATE M.NINOMI 2004/03/17		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	TITLE 0.4 B-TO-B CONN. REC HSG ASSY(HGT=1.5) EMBSTP PKG -LEAD FREE- MOLEX MOLEX INCORPORATED
		10 OVER 30 UNDER ±---		CHECKED BY DATE K.TOJO 2004/03/17					
		30 OVER ±---		APPROVED BY DATE M.SASAO 2004/03/17		MATERIAL NO.	DOCUMENT NO.	SHEET NO.	
		ANGULAR ±---°		SEE CHART					
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			
	REV								

